

# SP6019 Synchronous Rectifier Driver

### DESCRIPTION

The fundamental of SP6019 synchronous rectifier (SR) driver IC is based on our U.S. patented methods that utilize the principle of "prediction" logic circuit. The IC deliberates previous cycle timing to control the SR in present cycle by "predictive" algorithm that makes adjustments to the turn-off time, in order to achieve maximum efficiency and avoid cross-conduction at the same time. Specially, SP6019 is designed for Forward.

#### APPLICATIONS

- Servers & workstations
- Storage area network power supplies
- Telecommunication converters

**PIN CONFIGURATION (SOP-8)** 

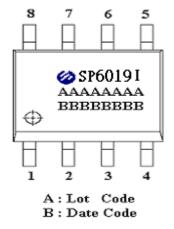
- Embedded systems
- Industrial & commercial systems using high current processors

#### FEATURES

- Offers efficiency improvement over Schottky Diode (depends on drive configuration of the SR).
- Drives all Power MOSFET.
- Prediction gate timing control.
- Minimum MOSFET body diode conduction.
- Operating frequency up to 400 KHz.
- Synchronize to transformer secondary voltage waveform.

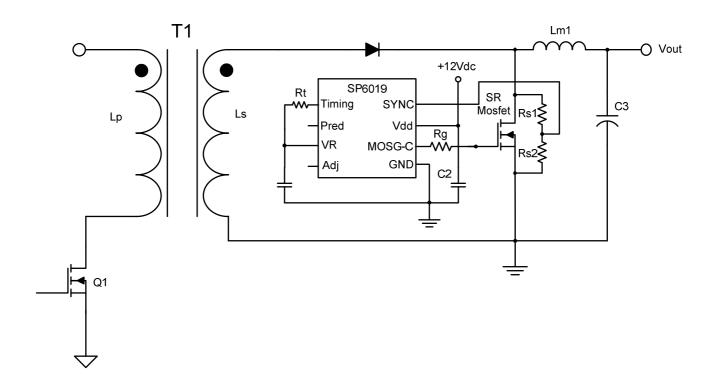
Timing	⊐[⊕	SYNC
Pred		🗖 Vdd
VR		🗖 MOSG-C
Adj		🗖 GND

## PART MARKING





# TYPICAL APPLCATION CIRCUIT

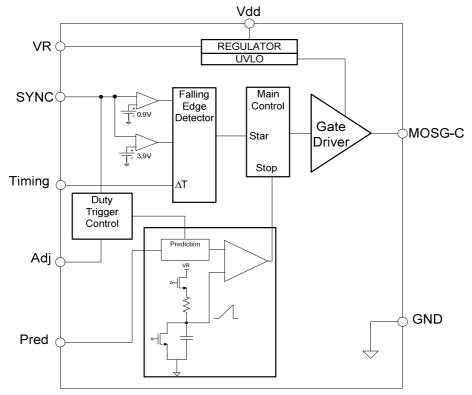


## **PIN DESCRIPTION**

Pin	Symbol	Description	
1	Timing	Discontinuous current filter timing adjustment resistor connection.	
2	Pred	Capacitor to store previous cycle timing for SR MOSFET.	
3	VR	Voltage Regulator.	
4	Adj	Trigger point adjustment for Dynamic state.	
5	GND	Ground connection.	
6	MOSG-C	Catch MOSFET gate drive.	
7	Vdd	DC supply voltage.	
8	SYNC	Synchronized signal from the V <sub>DS</sub> of SR MOSFET.	



# **BLOCK DIAGRAM**



## **ORDERING INFORMATION**

Part Number	Package	Part Marking
SP6019S8RGB	SOP-8	SP6019I
SP6019S8TGB	SOP-8	SP6019I

\* SP6019S8RGB : Tape Reel ; Pb – Free ; Halgon – Free

※ SP6019S8TGB : Tube ; Pb − Free ; Halgon − Free

#### ABSOULTE MAXIMUM RATINGS (TA=25°C, unless otherwise specified.)

The following ratings designate persistent limits beyond which damage to the device may occur.

Symbol	Parameter	Value	Unit
Vdd	DC Supply Voltage	16	V
VMOS-G	Output Voltage	16	V
VR	Voltage Regulator	-0.3~8	V
VTiming/pred/Adj/sync	Timing/Pred/Adj/Sync Voltage	-0.3~6	V
т	Peak Source Current (Pulsed)	2	А
$I_{OUT}$	Peak Sink Current (Pulsed)	2	А
P <sub>D</sub>	Power Dissipation @ $T_A = 85^{\circ}C$ (*)	0.25	W
T <sub>J</sub>	Operating Junction Temperature Range	-40 to125	°C
T <sub>STG</sub>	Storage Temperature Range	-40 to 150	°C
T <sub>LEAD</sub> Lead Soldering Temperature for 5 sec.		260	°C



## THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
Rojc	Thermal Resistance Junction – Case (*)	150	°C/W

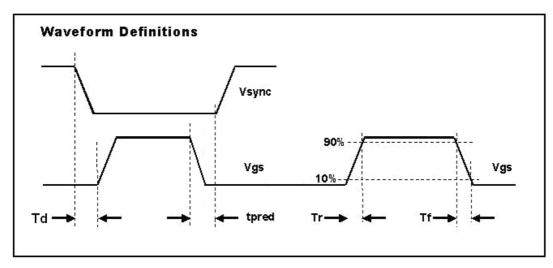
(\*) The power dissipation and thermal resistance are evaluated under copper board mounted with free air conditions.

#### **ELECTRICAL CHARACTERISTICS**

(T<sub>A</sub>=25°C, V<sub>dd</sub>=12V, Freq. =300 KHz, Duty Cycle=50%, unless otherwise specified.)

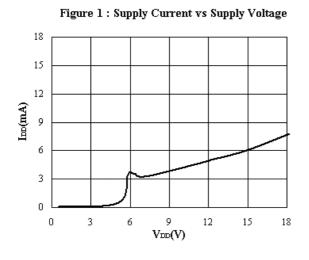
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
SUPPLY INI	PUT	I				-4
111	C	No load		4	7	mA
Idd	Supply current	V <sub>SYNC</sub> =0V, No load		5	8	mA
Vdd	Supply voltage	Idd <sub>peak</sub> < 2A			16	V
Vdd on	Enable voltage		9.4	10.0	10.5	V
SYNC REFE	ERENCE (SYNC)			·		
Vshth	SYNC high threshold			3.9		V
Vslth	SYNC low threshold			0.9		V
Vsync	SYNC clamp voltage	Isync=3mA		5		V
Isync	SYNC input current				3	mA
Voltage Regu	ulator REFERENCE (VR)					
Ivr	VR Output Current				20	mA
ON TIME D	UTY SETUP (PIN 6)					
Ton-time				20		us
MOSFET G.	ATE DRIVER (MOSG-C)					
Voh	Output high voltage	Io = -200 mA	10.5	11		V
Vol	Output low voltage	Io = 200 mA		0.5	0.8	V
Td	Propagation delay	No load	50	80		ns
Tpred		No load		120		ns
Tr	Rise time	No load		10	25	ns
Tf	Fall time	No load		10	25	ns
Dynamic Pro	otect			·		
Dt	Dynamic variable	Pin 4 open		600		ns
Ton-min	MOSG-C on time	PWM adjusts time > Dt		1		us

(\*) Tr & Tf are measured among 10% and 90% of starting and final voltage.

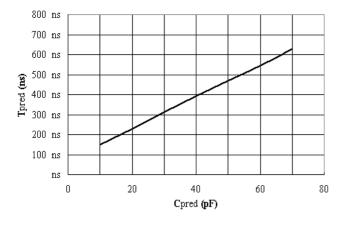




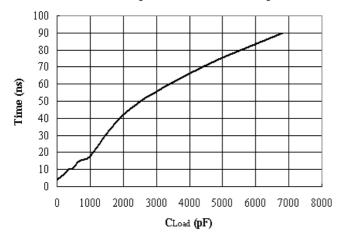
# **PERFORMANCE CHARACTERISTICS** (T<sub>A</sub>=25°C, unless otherwise specified.)

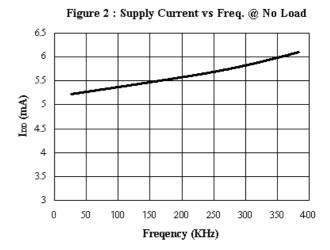




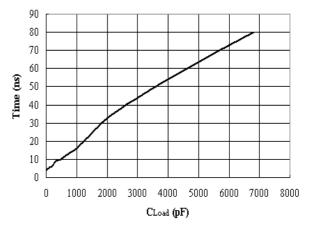


Fihure 5 : Output Fall Time vs Load Capacitor

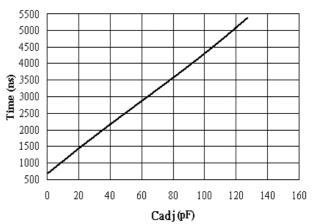




Fihure 4 : Output Rise Time vs Load Capacitor



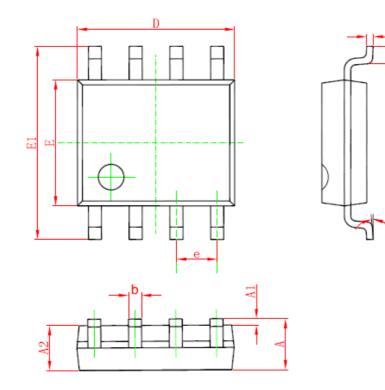




<sup>\*</sup>Fig. 1 : No Load ; No SYNC \*Fig. 4~5 : Frequency = 100 kHz.



## **SOP- 8 PACKAGE OUTLINE**



θ

0	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min	Max	Min	Max
A	1.350	1. 750	0.053	0.069
A1	0. 100	0. 250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0. 330	0.510	0.013	0. 020
с	0. 170	0. 250	0.006	0.010
D	4. 700	5. 100	0. 185	0. 200
E	3.800	4.000	0.150	0. 157
E1	5.800	6. 200	0. 228	0. 244
е	1. 270 (BSC)		0.050 (BSC)	
L	0. 400	1. 270	0.016	0.050
θ	0°	8°	0°	8°



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